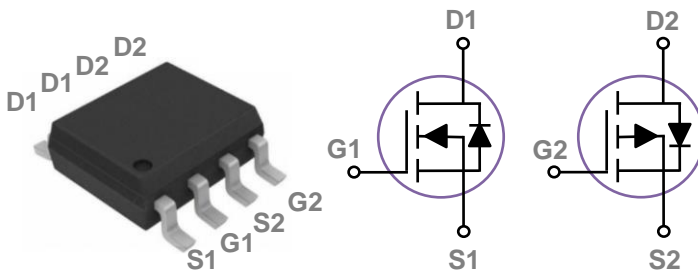


General Description

These N+P dual Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

SOP8 Pin Configuration



BVDSS	RDSON	ID
40V	32mΩ	6.7A
-40V	40mΩ	-7.2A

Features

- Fast switching
- Green Device Available
- Suit for 4.5V Gate Drive Applications

Applications

- DC Fan
- Motor Drive Applications
- Networking
- Half / Full Bridge Topology

Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating		Units
V_{DS}	Drain-Source Voltage	40	-40	V
V_{GS}	Gate-Source Voltage	± 20	± 20	V
I_D	Drain Current – Continuous ($T_A=25^\circ\text{C}$)	6.7	-7.2	A
	Drain Current – Continuous ($T_A=70^\circ\text{C}$)	5.4	-5.7	A
I_{DM}	Drain Current – Pulsed ¹	26.8	-28.8	A
P_D	Power Dissipation ($T_A=25^\circ\text{C}$)	2		W
	Power Dissipation – Derate above 25°C	0.016		W/ $^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to 150		$^\circ\text{C}$
T_J	Operating Junction Temperature Range	-55 to 150		$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to Ambient	---	62.5	$^\circ\text{C}/\text{W}$

N-CH Electrical Characteristics (T_J=25 °C, unless otherwise noted)
Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	40	---	---	V
ΔBV _{DSS} /ΔT _J	BV _{DSS} Temperature Coefficient	Reference to 25°C , I _D =1mA	---	0.04	---	V/°C
I _{DSS}	Drain-Source Leakage Current	V _{DS} =40V , V _{GS} =0V , T _J =25°C	---	---	1	uA
		V _{DS} =32V , V _{GS} =0V , T _J =125°C	---	---	10	uA
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±20V , V _{DS} =0V	---	---	±100	nA

On Characteristics

R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V , I _D =5A	---	24	32	mΩ
		V _{GS} =4.5V , I _D =3A	---	32	45	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250uA	1.0	1.8	2.5	V
ΔV _{GS(th)}	V _{GS(th)} Temperature Coefficient		---	-3	---	mV/°C
g _{fs}	Forward Transconductance	V _{DS} =10V , I _D =3A	---	3.6	---	S

Dynamic and switching Characteristics

Q _g	Total Gate Charge ^{2, 3}	V _{DS} =20V , V _{GS} =4.5V , I _D =3A	---	2.8	5.6	nC
Q _{gs}	Gate-Source Charge ^{2, 3}		---	0.5	1	
Q _{gd}	Gate-Drain Charge ^{2, 3}		---	1.5	3	
T _{d(on)}	Turn-On Delay Time ^{2, 3}	V _{DD} =20V , V _{GS} =4.5V , R _G =25Ω I _D =1A	---	3.2	6	ns
T _r	Rise Time ^{2, 3}		---	8.6	16	
T _{d(off)}	Turn-Off Delay Time ^{2, 3}		---	18	36	
T _f	Fall Time ^{2, 3}		---	6	12	
C _{iss}	Input Capacitance	V _{DS} =15V , V _{GS} =0V , F=1MHz	---	420	800	pF
C _{oss}	Output Capacitance		---	65	120	
C _{rss}	Reverse Transfer Capacitance		---	40	80	

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I _S	Continuous Source Current	V _G =V _D =0V , Force Current	---	---	6.7	A
I _{SM}	Pulsed Source Current		---	---	13.4	A
V _{SD}	Diode Forward Voltage	V _{GS} =0V , I _S =1A , T _J =25°C	---	---	1	V

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%.
3. Essentially independent of operating temperature.

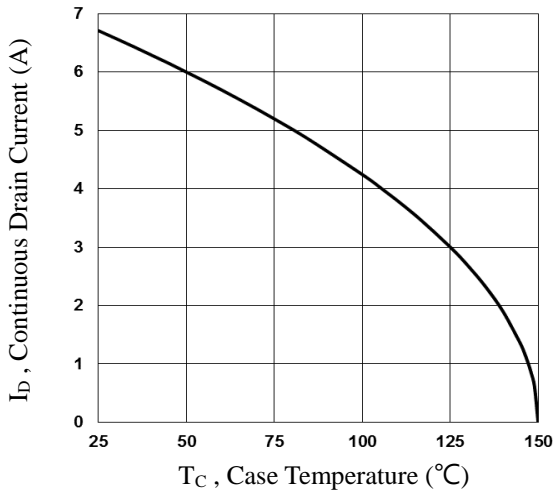


Fig.1 Continuous Drain Current vs. T_c

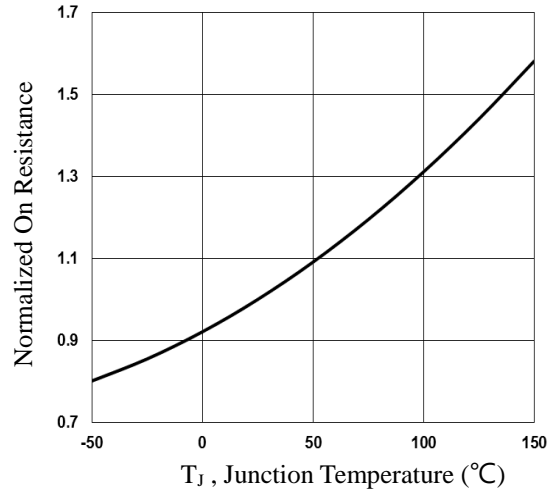


Fig.2 Normalized $R_{DS(on)}$ vs. T_j

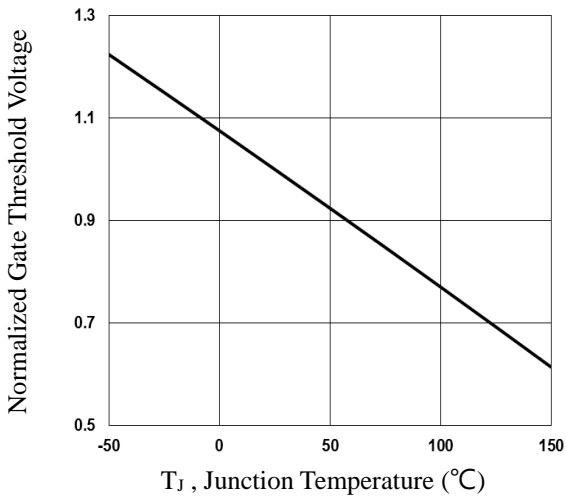


Fig.3 Normalized V_{th} vs. T_j

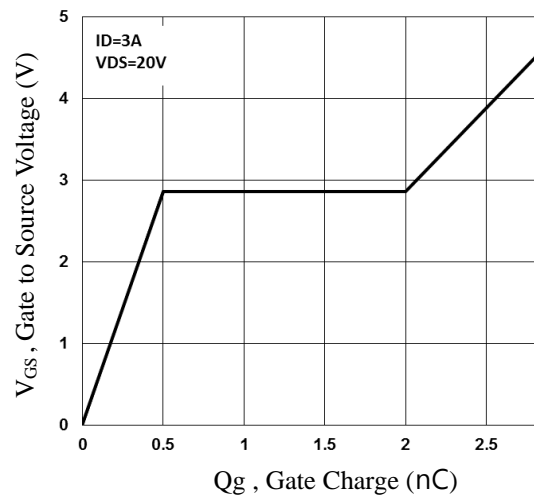


Fig.4 Gate Charge Waveform

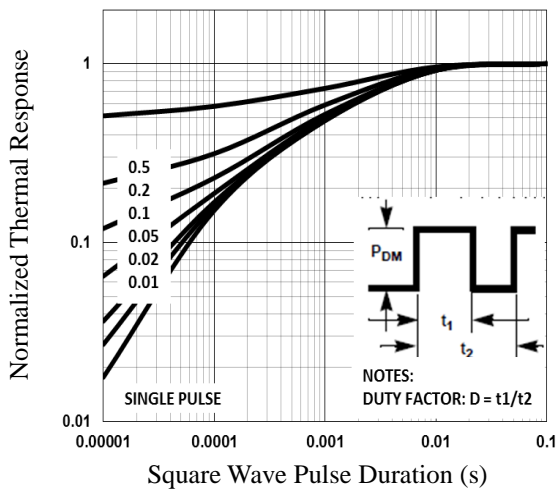


Fig.5 Normalized Transient Impedance

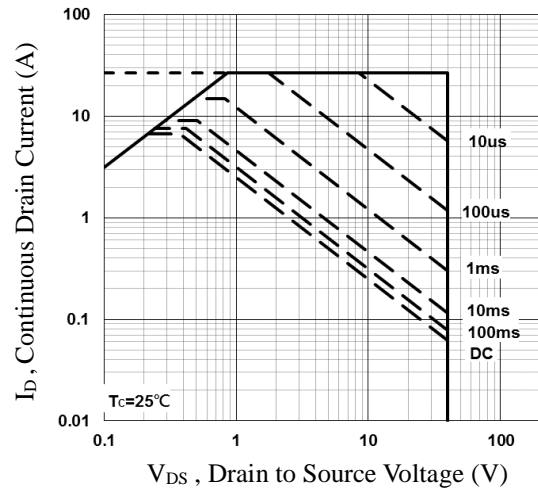


Fig.6 Maximum Safe Operation Area

P-CH Electrical Characteristics (T_J=25 °C, unless otherwise noted)
Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =-250uA	-40	---	---	V
ΔBV _{DSS} /ΔT _J	BV _{DSS} Temperature Coefficient	Reference to 25°C , I _D =-1mA	---	-0.04	---	V/°C
I _{DSS}	Drain-Source Leakage Current	V _{DS} =-40V , V _{GS} =0V , T _J =25°C	---	---	-1	uA
		V _{DS} =-32V , V _{GS} =0V , T _J =125°C	---	---	-10	uA
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±20V , V _{DS} =0V	---	---	±100	nA

On Characteristics

R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =-10V , I _D =-4A	---	32	40	mΩ
		V _{GS} =-4.5V , I _D =-2A	---	45	60	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =-250uA	-1.0	-1.6	-2.5	V
ΔV _{GS(th)}	V _{GS(th)} Temperature Coefficient		---	3	---	mV/°C
gfs	Forward Transconductance	V _{DS} =-10V , I _D =-3A	---	5	---	S

Dynamic and switching Characteristics

Q _g	Total Gate Charge ^{5, 6}	V _{DS} =-20V , V _{GS} =-4.5V , I _D =-2A	---	8	16	nC
Q _{gs}	Gate-Source Charge ^{5, 6}		---	2.1	4.2	
Q _{gd}	Gate-Drain Charge ^{5, 6}		---	3.6	7.2	
T _{d(on)}	Turn-On Delay Time ^{5, 6}	V _{DD} =-20V , V _{GS} =-4.5V , R _G =25Ω I _D =-1A	---	20	40	ns
T _r	Rise Time ^{5, 6}		---	12	24	
T _{d(off)}	Turn-Off Delay Time ^{5, 6}		---	46	80	
T _f	Fall Time ^{5, 6}		---	6	12	
C _{iss}	Input Capacitance	V _{DS} =-15V , V _{GS} =0V , F=1MHz	---	1050	1600	pF
C _{oss}	Output Capacitance		---	110	160	
C _{rss}	Reverse Transfer Capacitance		---	80	120	

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I _S	Continuous Source Current	V _G =V _D =0V , Force Current	---	---	-7.2	A
I _{SM}	Pulsed Source Current		---	---	-14.4	A
V _{SD}	Diode Forward Voltage	V _{GS} =0V , I _S =-1A , T _J =25°C	---	---	-1	V

Note :

4. Repetitive Rating : Pulsed width limited by maximum junction temperature.
5. The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%.
6. Essentially independent of operating temperature.

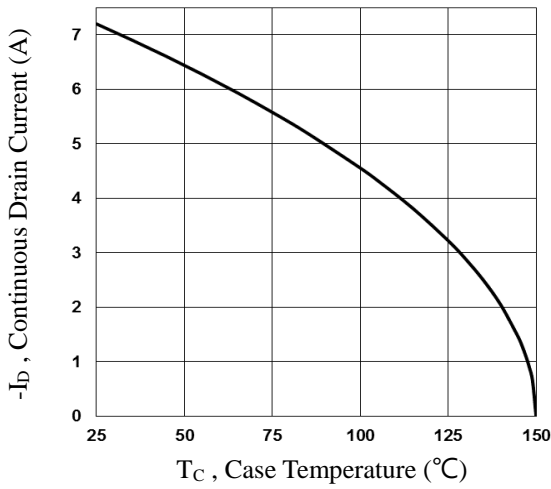


Fig.7 Continuous Drain Current vs. T_c

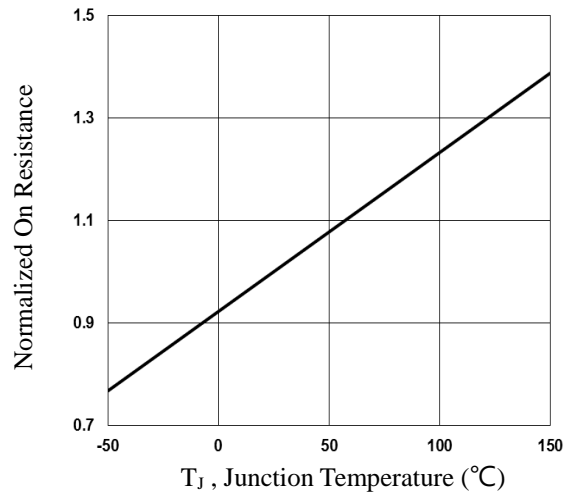


Fig.8 Normalized R_{DSon} vs. T_j

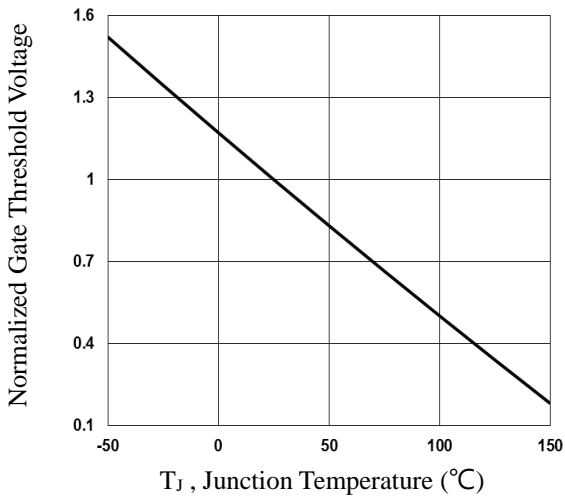


Fig.9 Normalized V_{th} vs. T_j

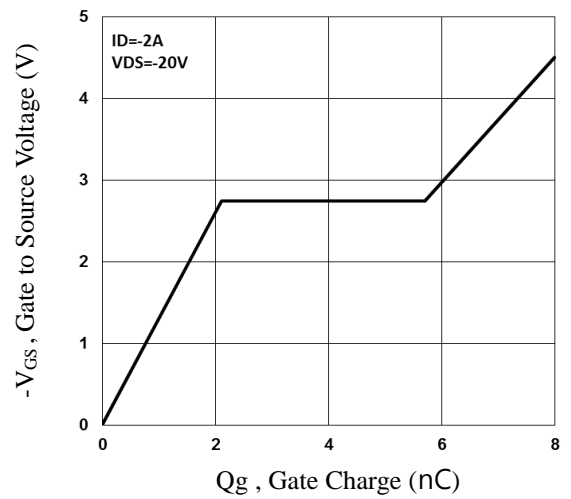


Fig.10 Gate Charge Waveform

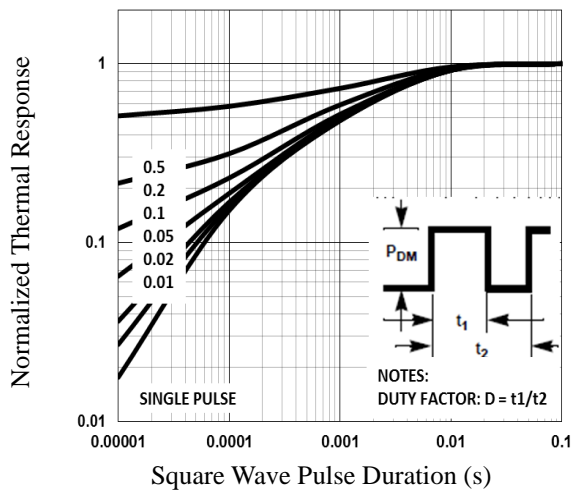


Fig.11 Normalized Transient Impedance

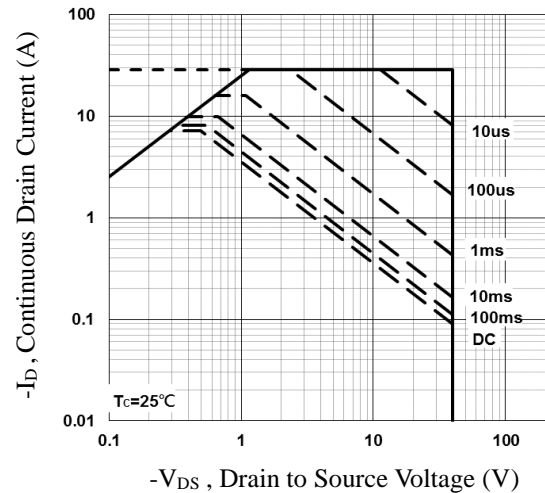
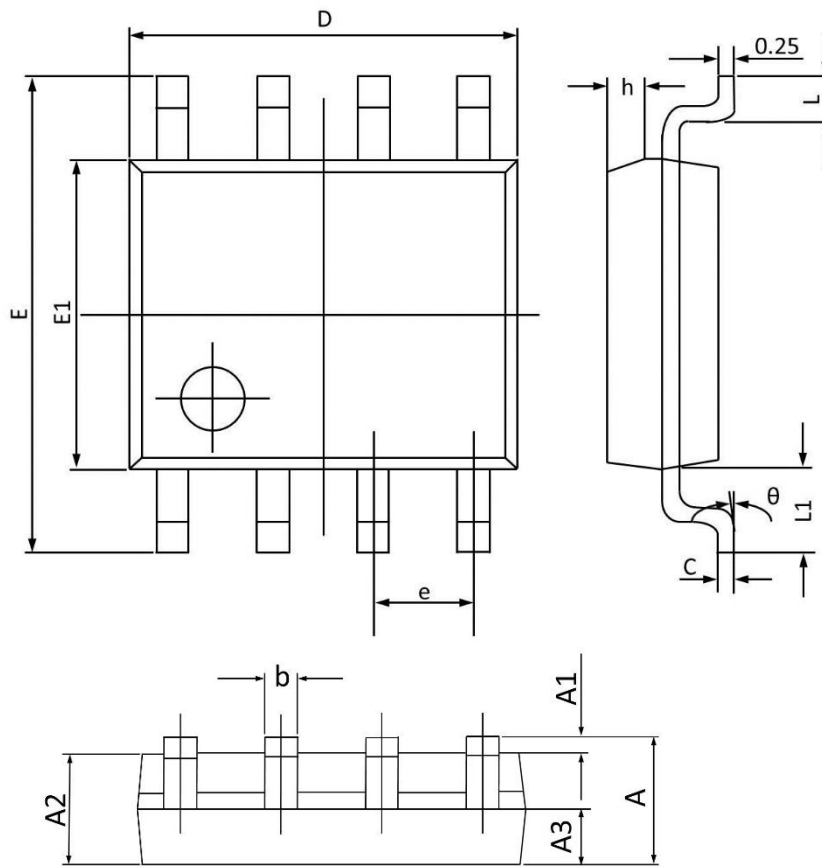


Fig.12 Maximum Safe Operation Area

SOP8 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.800	0.053	0.069
A1	0.050	0.250	0.002	0.010
A2	1.250	1.650	0.049	0.065
A3	0.500	0.700	0.020	0.028
b	0.300	0.510	0.012	0.020
c	0.150	0.260	0.006	0.010
D	4.700	5.100	0.185	0.201
E	5.800	6.200	0.228	0.244
E1	3.700	4.100	0.146	0.161
e	1.270(BSC)		0.050(BSC)	
h	0.250	0.500	0.010	0.020
L	0.400	1.000	0.016	0.039
L1	1.050(BSC)		0.041(BSC)	
θ	0°	8°	0°	8°